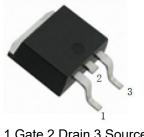
WTR03P075L-HAF

P-Channel Enhancement Mode MOSFET

Features

- Low On-Resistance
- · Low Miller Charge
- Halogen and Antimony Free(HAF), RoHS compliant

Gate Source



1.Gate 2.Drain 3.Source TO-252 Plastic Package

Applications

- Motor/Body Load Control
- Load Switch

Key Parameters

| Parameter | Value | Unit | |
|--------------------------|---------------------------------|------|--|
| -BV _{DSS} | 30 | V | |
| R _{DS(ON)} Max | 8.2 @ -V _{GS} = 10 V | m0 | |
| | 13.2 @ -V _{GS} = 4.5 V | mΩ | |
| -V _{GS(th)} typ | 1.4 | V | |
| Q _g typ | 63 @ -V _{GS} = 10 V | nC | |

Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

| Parameter | Symbol | Value | Unit | |
|--|---|----------------------|----------|---|
| Drain-Source Voltage | -V _{DS} | 30 | V | |
| Gate-Source Voltage | V_{GS} | V _{GS} ± 20 | | |
| Drain Current | T _c = 25°C T _c = 100°C | -I D | 61 38 | А |
| Peak Drain Current, Pulsed 1) | -I _{DM} | 250 | Α | |
| Single-Pulse Avalanche Current | -l _{AS} | 42 | Α | |
| Single-Pulse Avalanche Energy 2) | Eas | 88 | mJ | |
| Power Dissipation | T _c = 25°C | P _D | 48.3 | W |
| Operating Junction and Storage Temperature | T _J , T _{stg} | - 55 to + 150 | °C | |

Thermal Characteristics

| Parameter | Symbol | Max. | Unit |
|--|------------------|------|------|
| Thermal Resistance from Junction to Case | Rejc | 2.5 | °C/W |
| Thermal Resistance from Junction to Ambient 3) | R _{θJA} | 35 | °C/W |

¹⁾ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.



 $^{^{2)}}$ Limited by $T_{J(MAX)},$ starting T_J = 25°C, L = 0.1 mH, R_g = 25 $\Omega,$ -I $_D$ = 42 A, -V $_{GS}$ = 10 V.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

WTR03P075L-HAF

Characteristics at Ta = 25°C unless otherwise specified

| Characteristics at T _a = 25°C unless otherwise specified Parameter | | Min | T.m | Max | Linit |
|--|----------------------|--------|----------|-------------|-------|
| | Symbol | Min. | Тур. | Max. | Unit |
| STATIC PARAMETERS | <u> </u> | | | I | T |
| Drain-Source Breakdown Voltage at -I _D = 250 µA | -BV _{DSS} | 30 | - | - | V |
| Drain-Source Leakage Current at -V _{DS} = 24 V | -I _{DSS} | - | - | 1 | μΑ |
| Gate Leakage Current at $V_{GS} = \pm 20 \text{ V}$ | Igss | - | - | ± 100 | nA |
| Gate-Source Threshold Voltage at V _{DS} = V _{GS} , -I _D = 250 μA | -V _{GS(th)} | 1 | - | 2.3 | V |
| Drain-Source On-State Resistance at -V _{GS} = 10 V, -I _D = 20 A at -V _{GS} = 4.5 V, -I _D = 10 A | R _{DS(on)} | - - | 6.8 | 8.2 13.2 | mΩ |
| DYNAMIC PARAMETERS | | | | | |
| Forward Transconductance at -V _{DS} = 5 V, -I _D = 20 A | g FS | - | 32 | - | S |
| Gate Resistance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ | Rg | - | 2.8 | - | Ω |
| Input Capacitance at $-V_{DS} = 15 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ | Ciss | - | 3864 | - | pF |
| Output Capacitance at $-V_{DS} = 15 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ | Coss | - | 392 | - | pF |
| Reverse Transfer Capacitance at $-V_{DS} = 15 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ | Crss | - | 257 | - | pF |
| Total Gate Charge at $-V_{GS} = 10 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_{D} = 20 \text{ A}$ at $-V_{GS} = 4.5 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $-I_{D} = 20 \text{ A}$ | Qg | - | 63 29 | | nC |
| Gate-Source Charge at -V _{GS} = 10 V, -V _{DS} = 15 V, -I _D = 20 A | Q _{gs} | - | 12 | - | nC |
| Gate-Drain Charge at -V _{GS} = 10 V, -V _{DS} = 15 V, -I _D = 20 A | Q_{gd} | - | 9 | - | nC |
| Turn-On Delay Time at -V _{DD} = 15 V, -V _{GS} = 10 V, -I _D = 20 A, R _G = 3.3 Ω | t _{d(on)} | - | 22 | - | ns |
| Turn-On Rise Time at -V _{DD} = 15 V, -V _{GS} = 10 V, -I _D = 20 A, R _G = 3.3 Ω | t _r | - | 59 | - | ns |
| Turn-Off Delay Time at -V _{DD} = 15 V, -V _{GS} = 10 V, -I _D = 20 A, R _G = 3.3 Ω | t _{d(off)} | - | 26 | - | ns |
| Turn-Off Fall Time at -V _{DD} = 15 V, -V _{GS} = 10 V, -I _D = 20 A, R _G = 3.3 Ω | t _f | - | 17 | - | ns |
| Body-Diode PARAMETERS | | | | | |
| Drain-Source Diode Forward Voltage at -Is = 1 A, V_{GS} = 0 V | -V _{SD} | - | - | 1.2 | V |
| Body-Diode Continuous Current | -Is | - | - | 61 | Α |
| Body-Diode Continuous Current, Pulsed | -I _{SM} | - | - | 250 | Α |
| Body Diode Reverse Recovery Time at -ls = 20 A, di/dt = 100 A / µs | t _{rr} | - | 15 | - | ns |
| Body Diode Reverse Recovery Charge at -ls = 20 A, di/dt = 100 A / µs | Qrr | - | 7 | - | nC |



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristic

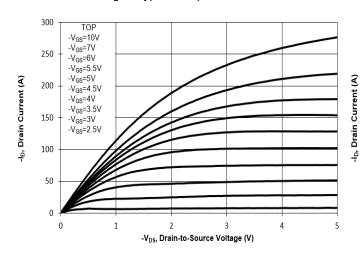


Fig. 2 Typical Transfer Characteristic

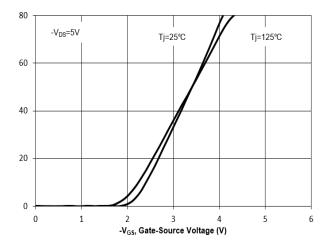


Fig. 3 On-Resistance vs. Drain Current

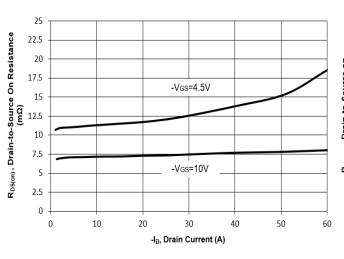


Fig. 4 On-Resistance vs. Gate Voltage

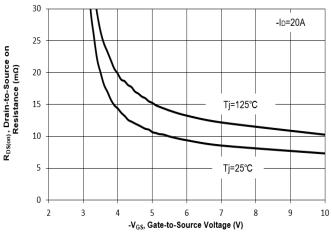


Fig. 5 On-Resistance vs.T_j

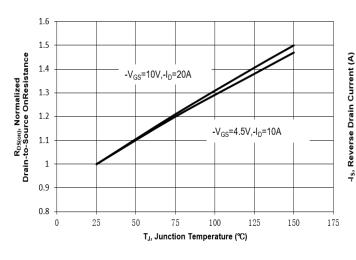
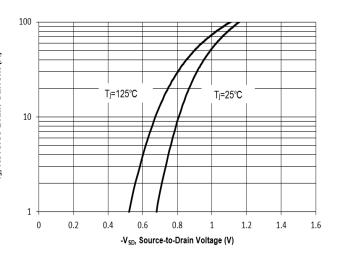


Fig. 6 Typical Body-Diode Forward Characteristic





Electrical Characteristics Curves

electrical Characteristics Curves

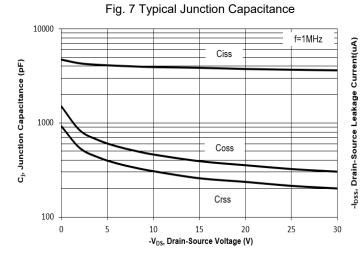


Fig. 8 Drain-Source Leakage Current vs. Tj

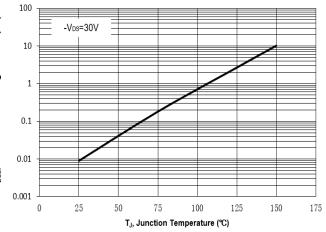


Fig. 9 V_{(BR)DSS} vs. Junction Temperature

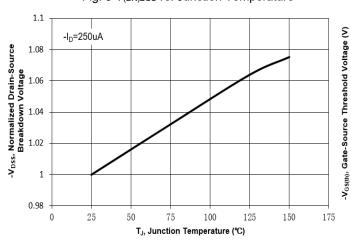


Fig. 10 Gate Threshold Variation vs. Ti

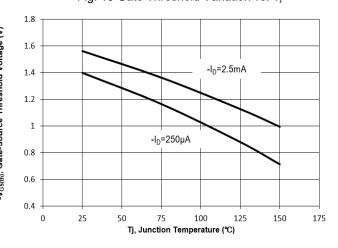


Fig. 11 Gate Charge

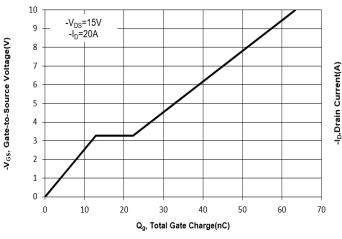
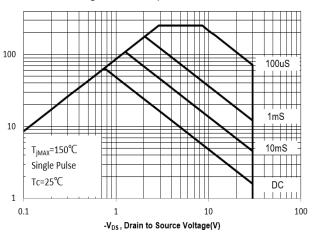


Fig. 12 Safe Operation Area





Electrical Characteristics Curves

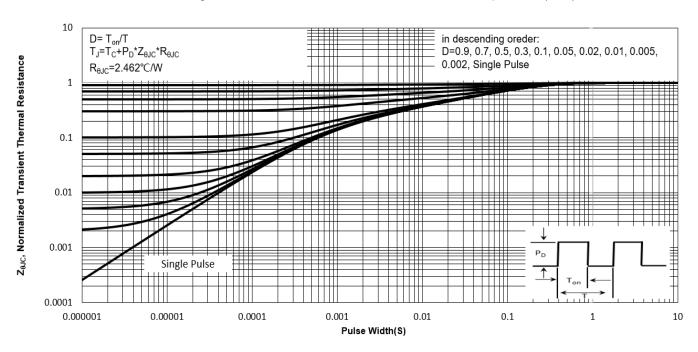
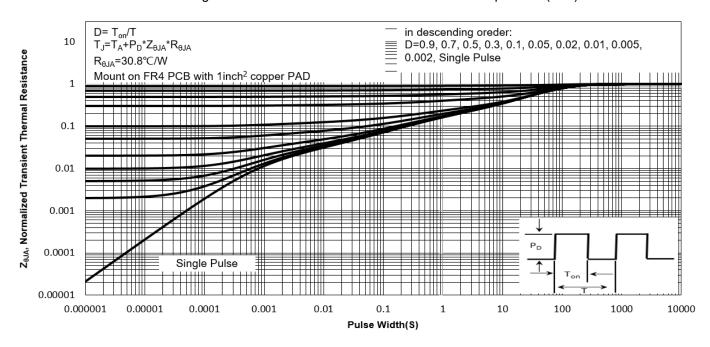


Fig. 13 Normalized Maximum Transient Thermal Impedance(zeuc)







WTR03P075L-HAF

Test Circuits

rest officials

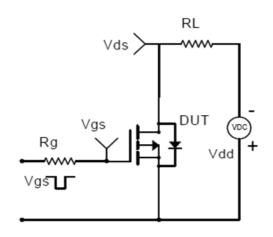


Fig.1-1 Switching times test circuit

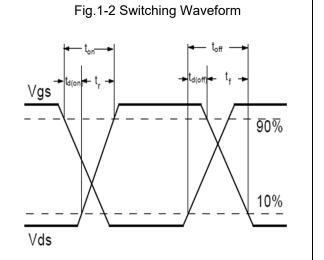


Fig.2-1 Gate charge test circuit

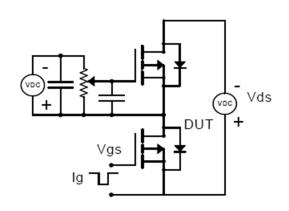


Fig.2-2 Gate charge waveform

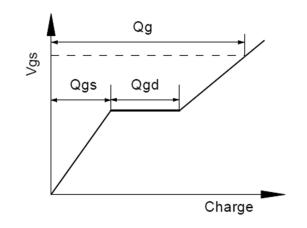


Fig.3-1 Avalanche test circuit

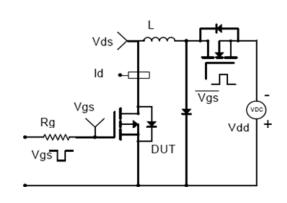
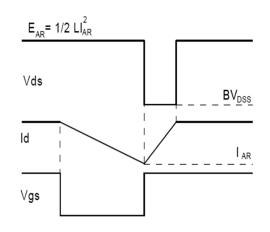


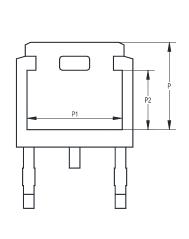
Fig.3-2 Avalanche waveform

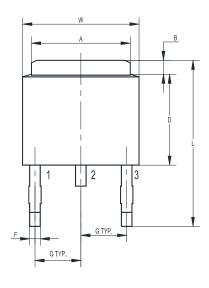


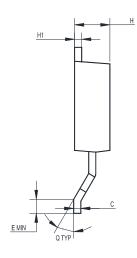


Package Outline (Dimensions in mm)

TO-252



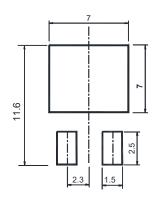






| Ī | UNIT | Α | В | С | D | E | F | G | W | Н | H1 | Q | L | Р | P1 | P2 |
|---|------|-----|------|------|-----|-----|-----|-----|-----|-----|------|-----|------|-----|-----|-----|
| | | 5.5 | 1.20 | 0.65 | 6.2 | 8.0 | 1.0 | 2.3 | 6.7 | 2.5 | 0.65 | 60° | 10.7 | 5.4 | 5.0 | 3.4 |
| | mm | 4.9 | 0.85 | 0.4 | 5.6 | MIN | 0.5 | TYP | 6.1 | 2.1 | 0.4 | TYP | 9 | 5.0 | 4.6 | 2.9 |

Recommended Soldering Footprint



Packing information

| Package | Tape Width | Pit | tch | Reel | Size | Por Pool Packing Quantity |
|---------|------------|---------|---------------|------|------|---------------------------|
| Раскауе | (mm) | mm | inch | mm | inch | Per Reel Packing Quantity |
| TO-252 | 12 | 8 ± 0.1 | 0.315 ± 0.004 | 330 | 13 | 2,500 |

Marking information

" TR03P075L " = Part No.

" ***** " = Date Code Marking

Font type: Arial





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